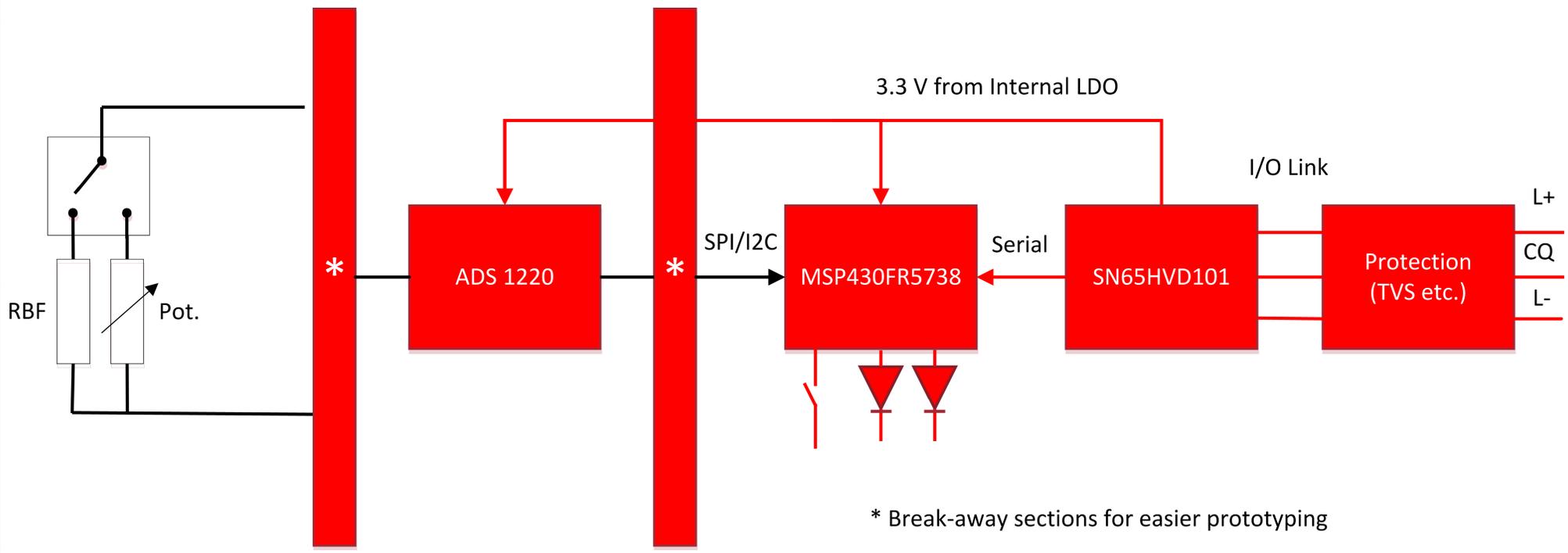


Revision History	
Revision	Notes



* Break-away sections for easier prototyping

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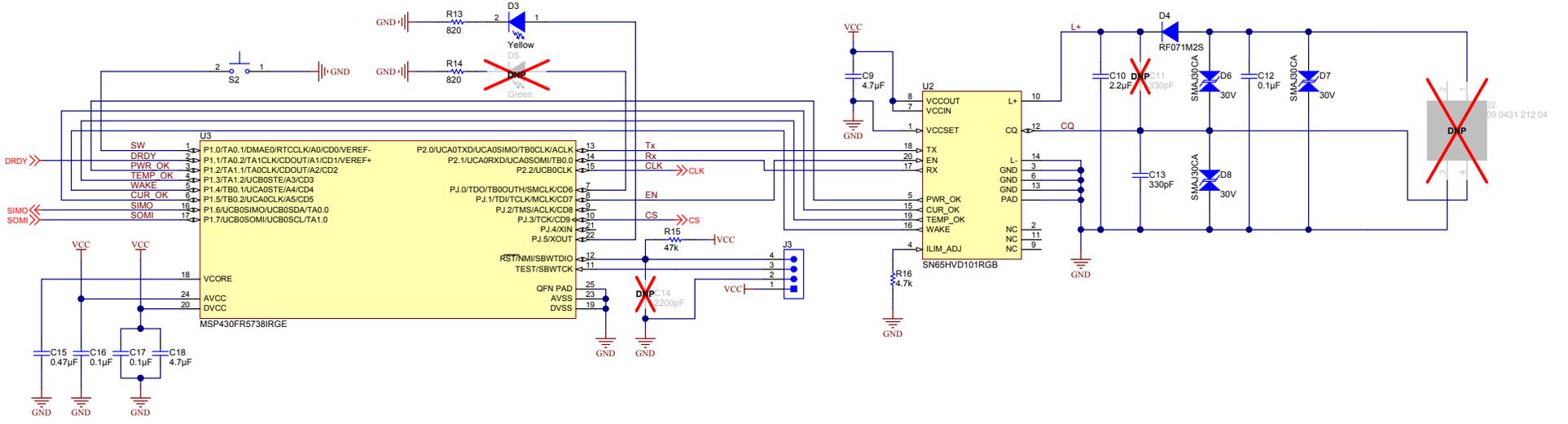
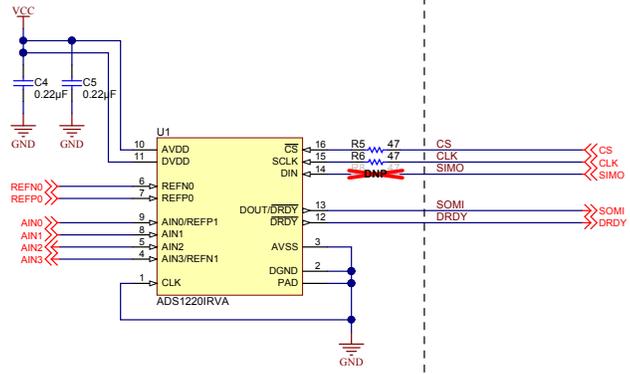
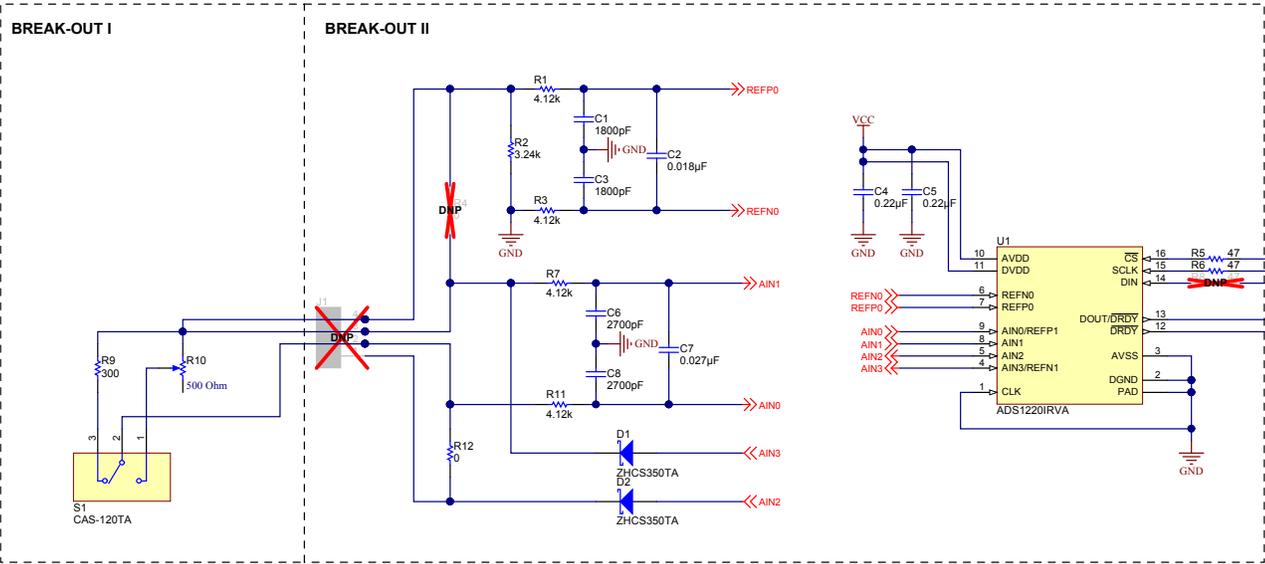
Number: TIDA-00188	Rev: E2	Designed for: Public Release	Mod. Date: 9/15/2014
SVN Rev: Version control disabled	Assembly Variant: TIDA-00188	Project Title: IO-Link Sensor	Sheet Title:
Drawn By:	File: Cover Sheet_ANSI-B_SchDoc	Sheet: 1 of 2	Size: B
Engineer: FA&C	Contact: http://www.ti.com/support	 http://www.ti.com	



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2-, 3-, 4-wire configuration:
 2-wire: R4=0R; R12=0R
 3-wire (default): R4=DNP; R12=0R
 4-wire: R4=DNP; R12=DNP

Connector J1
 J1 can be used for 2-, 3- and 4-wire connection of a separate sensor.
 2-wire: Use PINS 2 & 3
 3-wire: Use PINS 2 & 3/4
 4-wire: Use PINS 1/2 & 3/4
 NOTE: break-out section 1 should be physically removed



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Number: TIDA-00188	Rev: E2	Designed for: Public Release	Mod. Date: 4/22/2014
SVN Rev: Version control disabled	Assembly Variant: TIDA-00188	Project Title: IO-Link Sensor	Sheet: 2 of 2
Drawn By: AW	File: TIDA-00188_E2_SchDoc	Sheet Title: IO-Link Sensor	Size: B
Engineer: FA&C	Contact: http://www.ti.com/support		



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